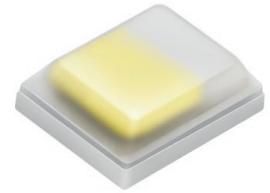


CW CBLPM1.W1

CERAMOS® Gen 4.H

Highly efficient lightsource, slim package design



Applications

- Flash & Autofocus

Features:

- Package: SMD ceramic package with diffused silicone resin
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.5, Cy = 0.43 acc. to CIE 1931 (● warm white)
- Corrosion Robustness Class: 3B
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2); 8 kV acc. to IEC 61000-4-2, level 4 (contact discharge)

Ordering Information

Type	Luminous Flux ¹⁾ $I_F = 1000 \text{ mA}$ Φ_V	Ordering Code
CW CBLPM1.W1-LZMZ-S2S3	150 ... 280 lm	Q65111A6863
CW CBLPM1.W1-MXMZ-S1S2	180 ... 280 lm	Q65111A5966

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min.	-40 °C
		max.	85 °C
Storage Temperature	T_{stg}	min.	-40 °C
		max.	85 °C
Junction Temperature ²⁾	T_j	max.	150 °C
Junction Temperature Pulse ³⁾	T_j	max.	175 °C
Forward Current ²⁾ $T_s = 25\text{ °C}$	I_F	min.	30 mA
		max.	500 mA
Forward Current pulsed ³⁾ $D = 0.016 ; T_s = 25\text{ °C}$	$I_{F\ pulse}$	max.	2000 mA
Reverse current ⁴⁾	I_R	max.	200 mA

Characteristics

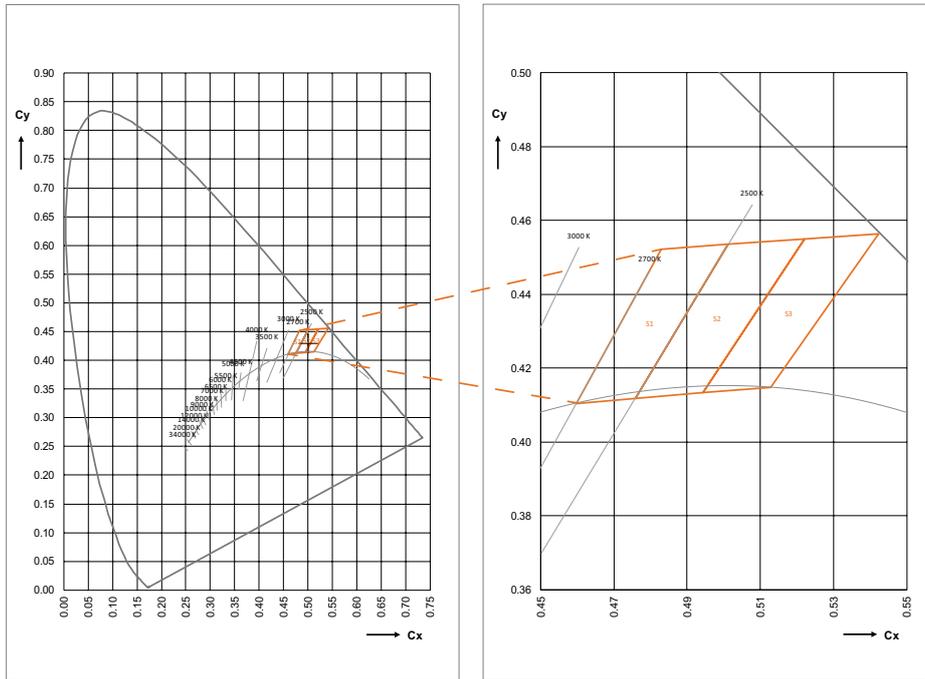
$I_F = 1000 \text{ mA}$; $T_S = 25 \text{ }^\circ\text{C}$

Parameter	Symbol		Values
Chromaticity Coordinate ⁵⁾	Cx	typ.	0.5
	Cy	typ.	0.43
Viewing angle at 50% I_V	2ϕ	typ.	120 °
Forward Voltage ⁶⁾ $I_F = 1000 \text{ mA}$	V_F	min.	2.95 V
		typ.	3.26 V
		max.	3.70 V
Reverse voltage (ESD device)	$V_{R\text{ESD}}$	min.	5 V
Reverse voltage ⁴⁾ $I_R = 20 \text{ mA}$	V_R	max.	1.2 V
Electrical thermal resistance junction/solderpoint ⁷⁾ with efficiency $\eta_e = 27 \text{ } \%$	$R_{\text{thJS elec.}}$	typ.	8.0 K / W

Brightness Groups

Group	Luminous Flux ¹⁾ $I_F = 1000 \text{ mA}$ min. Φ_V	Luminous Flux ¹⁾ $I_F = 1000 \text{ mA}$ max. Φ_V
LZ	150 lm	180 lm
MX	180 lm	210 lm
MY	210 lm	240 lm
MZ	240 lm	280 lm

Chromaticity Coordinate Groups



Chromaticity Coordinate Groups ⁵⁾

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
S1	0.4759	0.4118	S2	0.4944	0.4133	S3	0.5128	0.4148
	0.5012	0.4535		0.5220	0.4549		0.5424	0.4564
	0.4830	0.4522		0.5012	0.4535		0.5220	0.4549
	0.4598	0.4105		0.4759	0.4118		0.4944	0.4133

Group Name on Label

Example: LZ-S1

Brightness

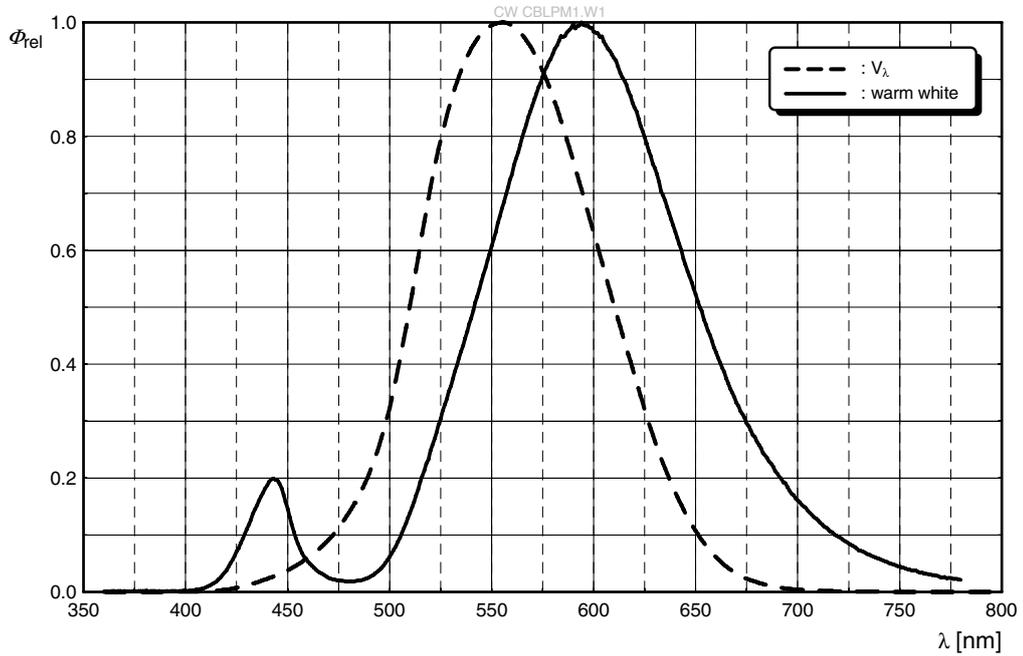
Color Chromaticity

LZ

S1

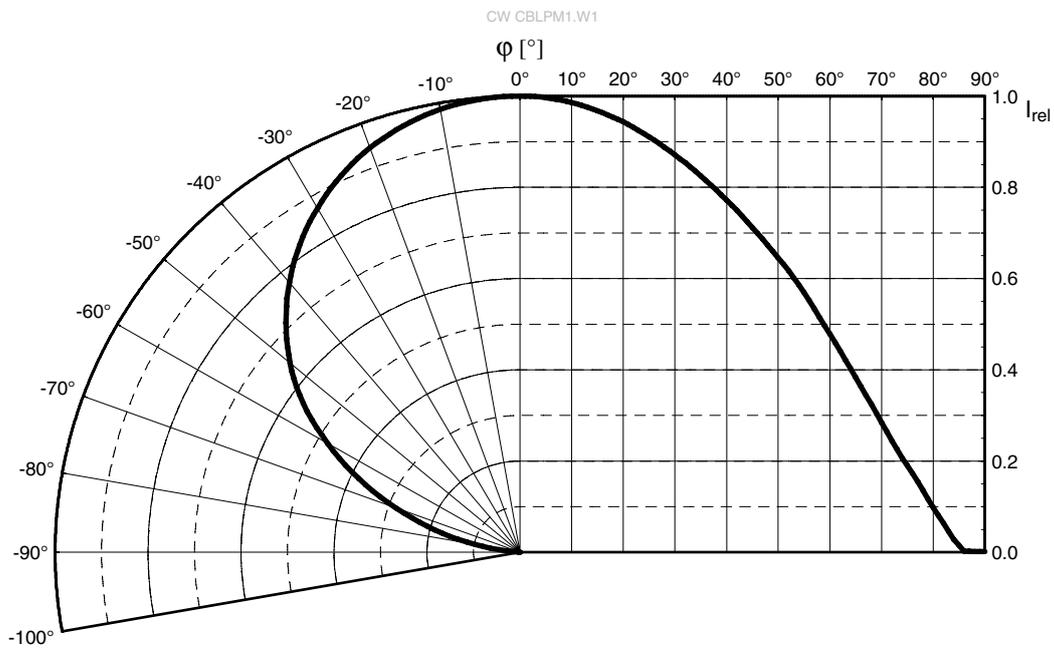
Relative Spectral Emission ⁸⁾

$I_{rel} = f(\lambda); I_F = 1000 \text{ mA}; T_J = 25 \text{ }^\circ\text{C}$



Radiation Characteristics ⁸⁾

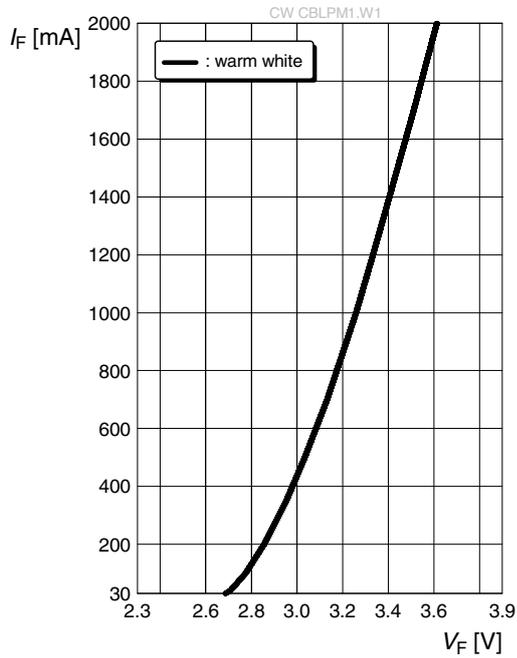
$I_{rel} = f(\phi); T_J = 25 \text{ }^\circ\text{C}$



Discontinued

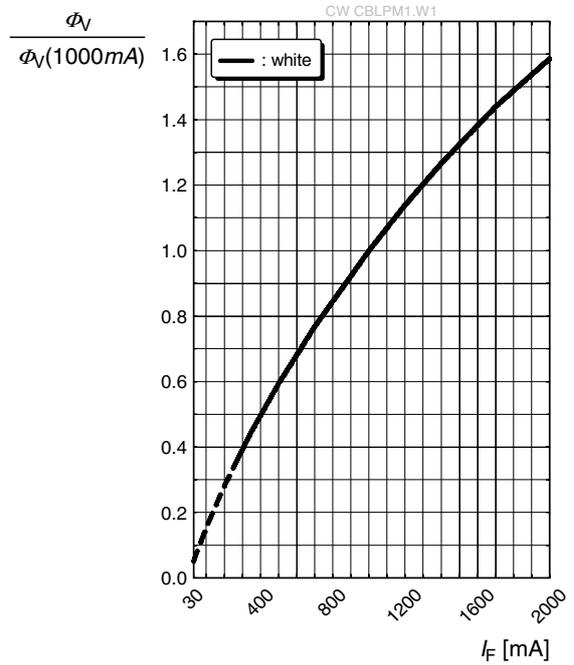
Forward current 8), 9)

$I_F = f(V_F); T_J = 25\text{ }^\circ\text{C}$



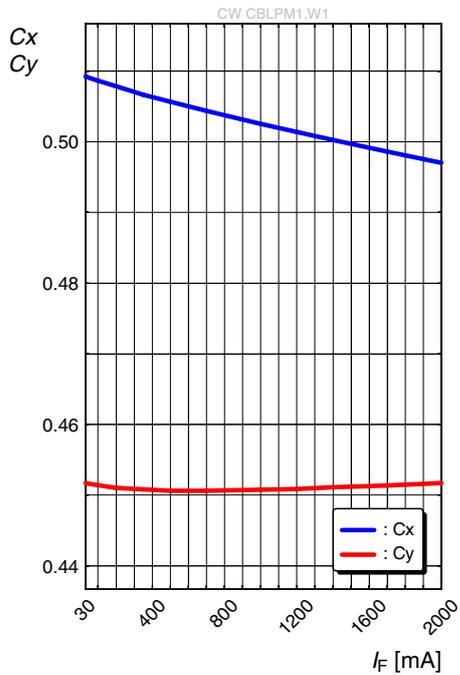
Relative Luminous Flux 8), 9)

$\Phi_V / \Phi_V(1000\text{ mA}) = f(I_F); T_J = 25\text{ }^\circ\text{C}$



Chromaticity Coordinate Shift 8)

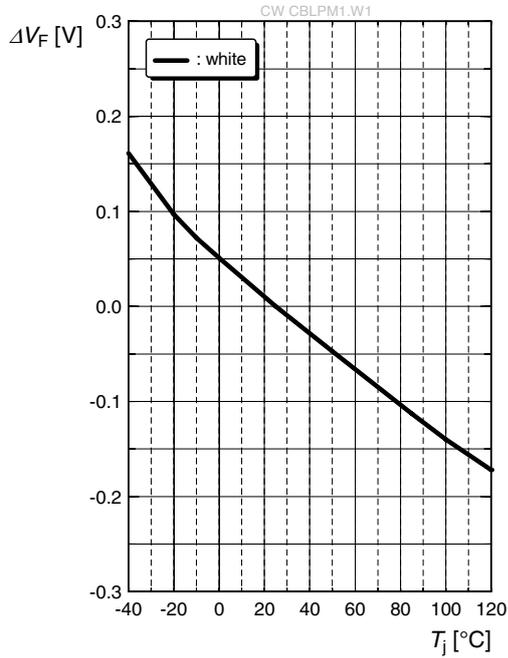
$C_x, C_y = f(I_F); T_J = 25\text{ }^\circ\text{C}$



Discontinued

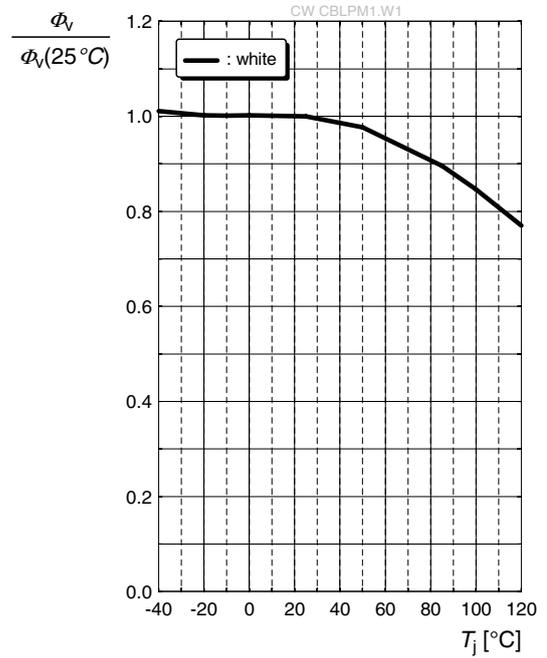
Forward Voltage ⁸⁾

$\Delta V_F = V_F - V_F(25\text{ }^\circ\text{C}) = f(T_j); I_F = 1000\text{ mA}$



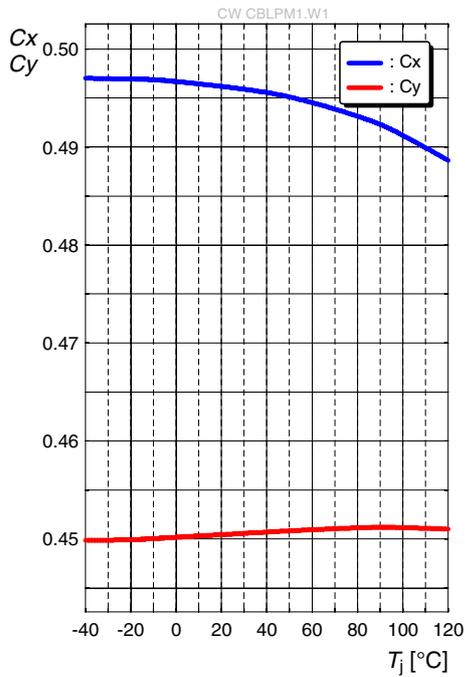
Relative Luminous Flux ⁸⁾

$\Phi_V / \Phi_V(25\text{ }^\circ\text{C}) = f(T_j); I_F = 1000\text{ mA}$



Chromaticity Coordinate Shift ⁸⁾

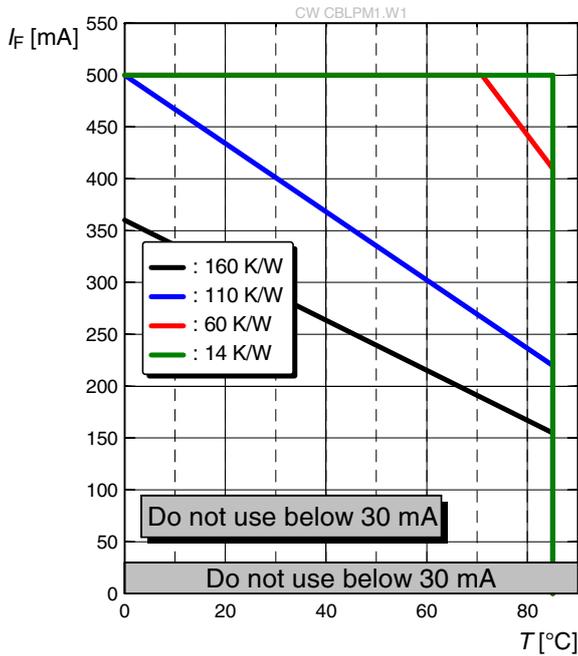
$C_x, C_y = f(T_j); I_F = 1000\text{ mA}$



Discontinued

Max. Permissible Forward Current

$$I_F = f(T)$$



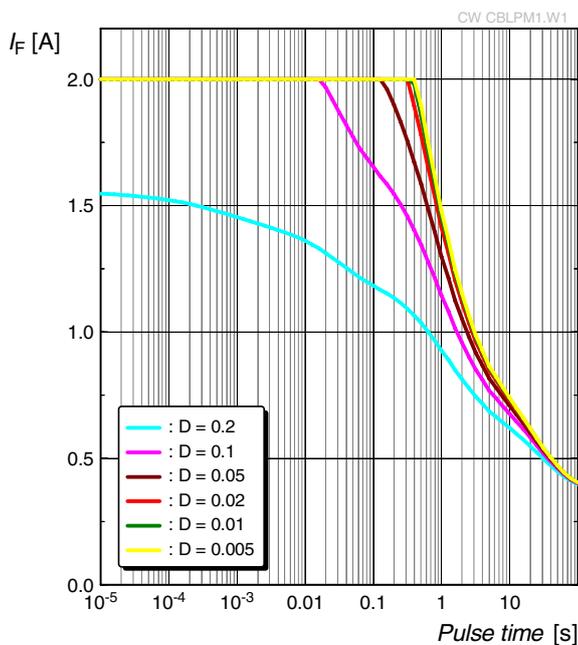
Note:

Deratings strongly relate on the boundary conditions of each individual device:

- The DC-derating on the left represents several thermal resistance values $R_{th JA}$ (Junction/Ambient) as examples.
- The shown pulse-deratings represent just one of alternative options for use. For further information please refer to application note „Thermal Management of Flash LEDs“.

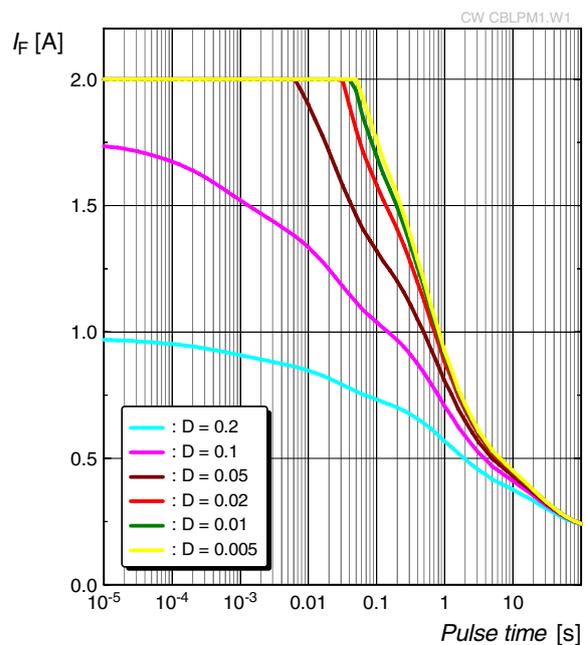
Permissible Pulse Handling Capability

$$R_{th JA el} = 160 \text{ K/W}; T_A = 25 \text{ °C}; \text{ still air; FR4}$$



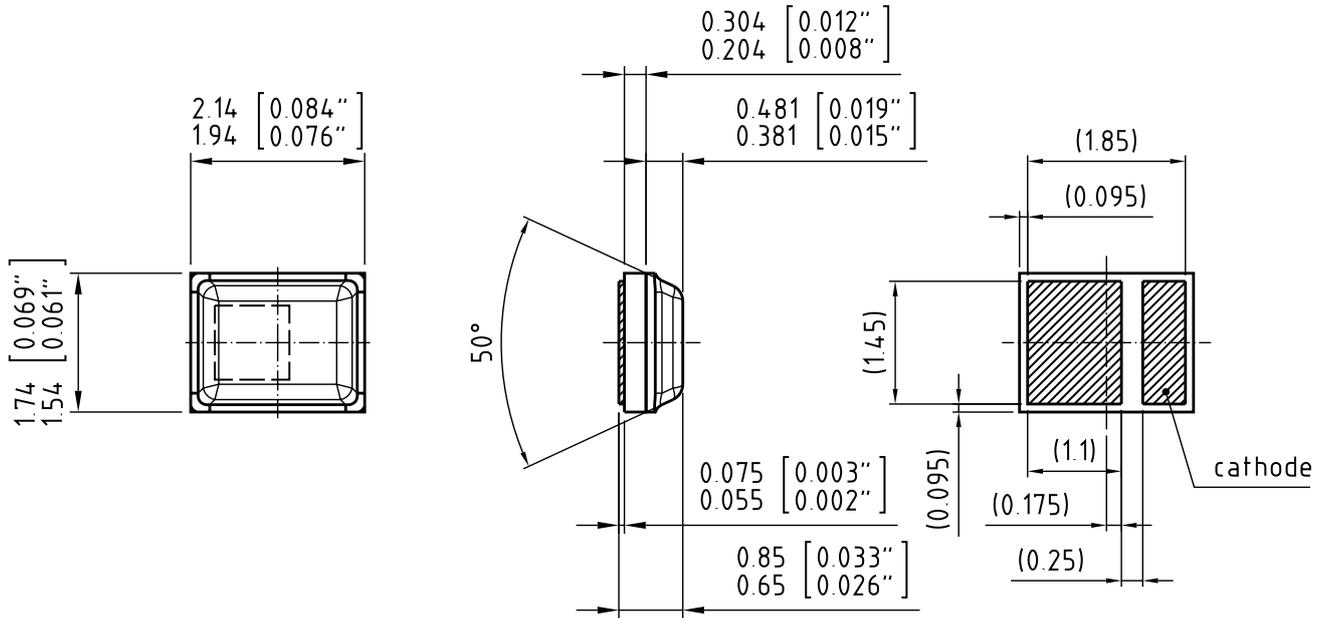
Permissible Pulse Handling Capability

$$R_{th JA el} = 160 \text{ K/W}; T_A = 85 \text{ °C}; \text{ still air; FR4}$$



Discontinued

Dimensional Drawing ¹⁰⁾



C63062-A4053-A1.-06

Further Information

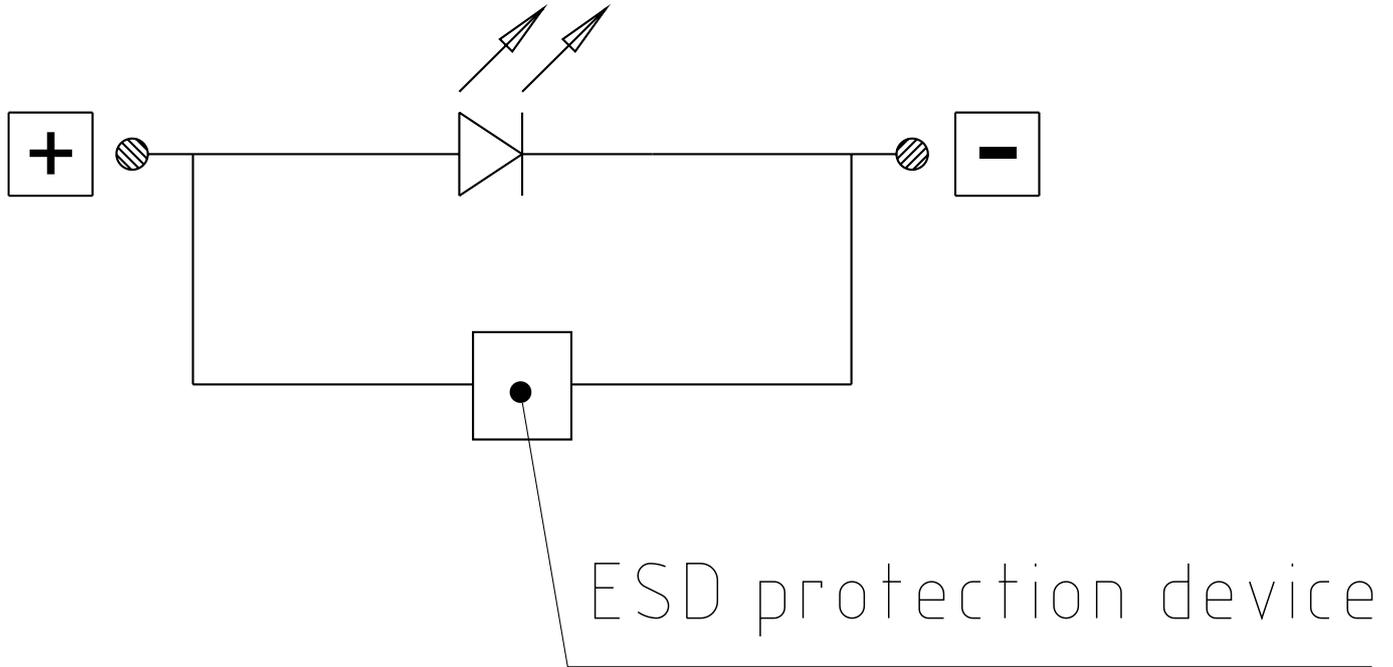
Approximate Weight: 8.2 mg

Corrosion test: Class: 3B
 Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC 60068-2-43)

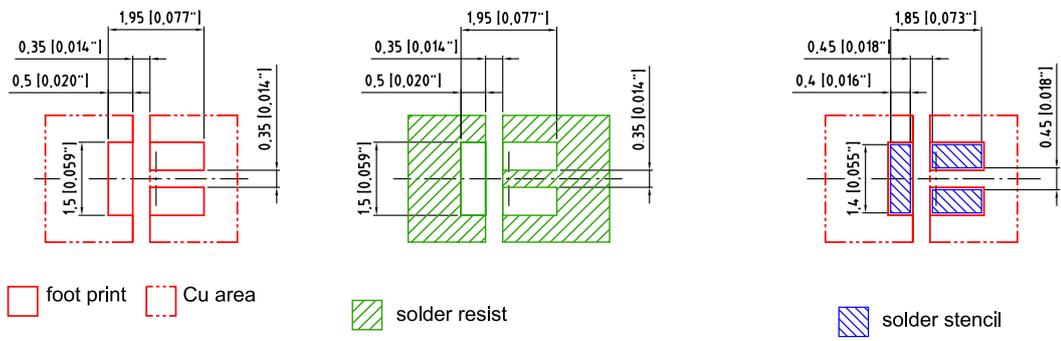
ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

Discontinued

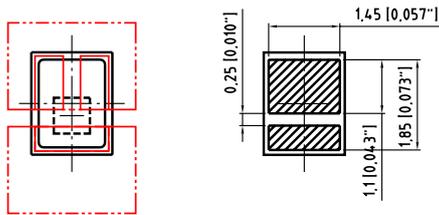
Electrical Internal Circuit



Recommended Solder Pad ¹⁰⁾



Component Location on Pad



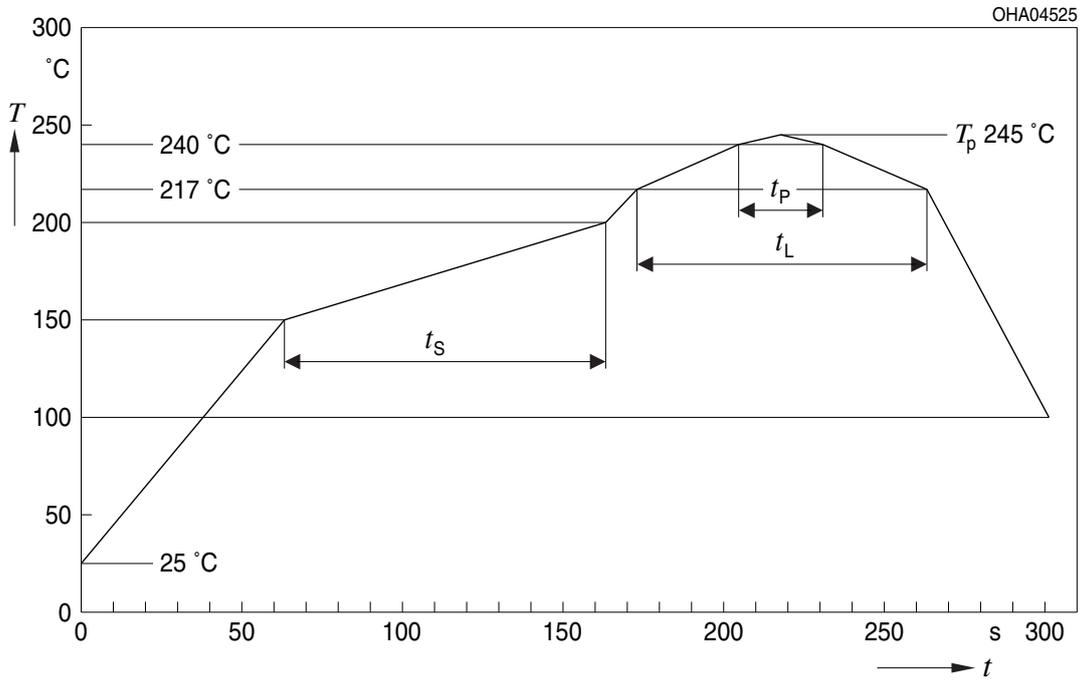
E062.3010.136 -01

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Discontinued

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

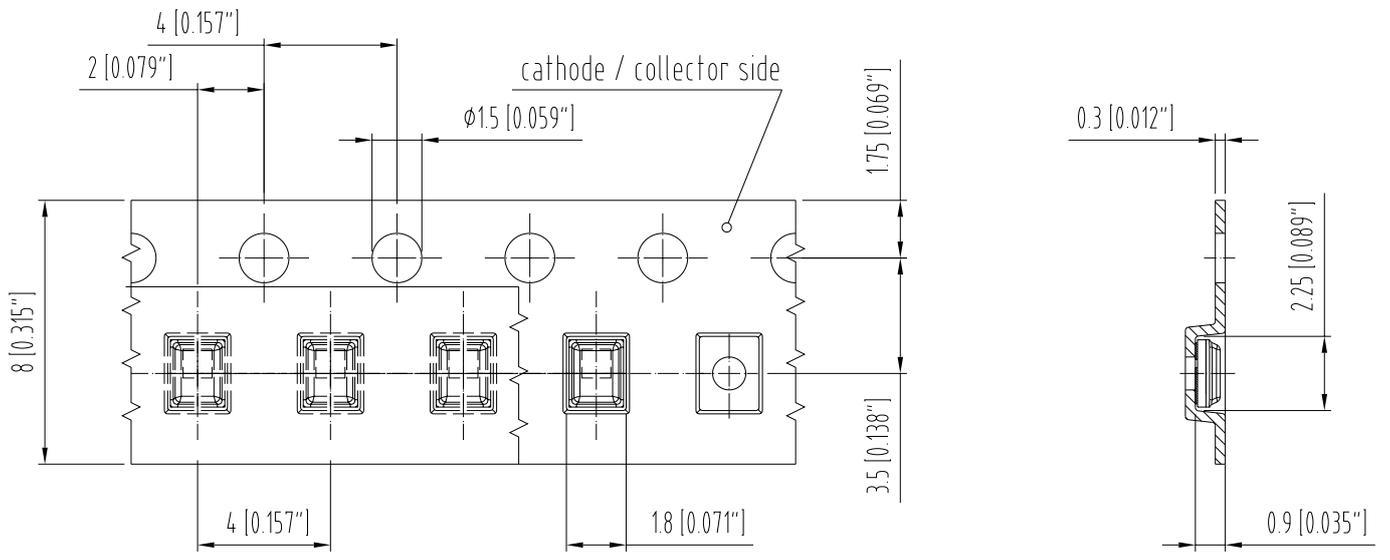


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak ^{*)} T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component
 *) slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Discontinued

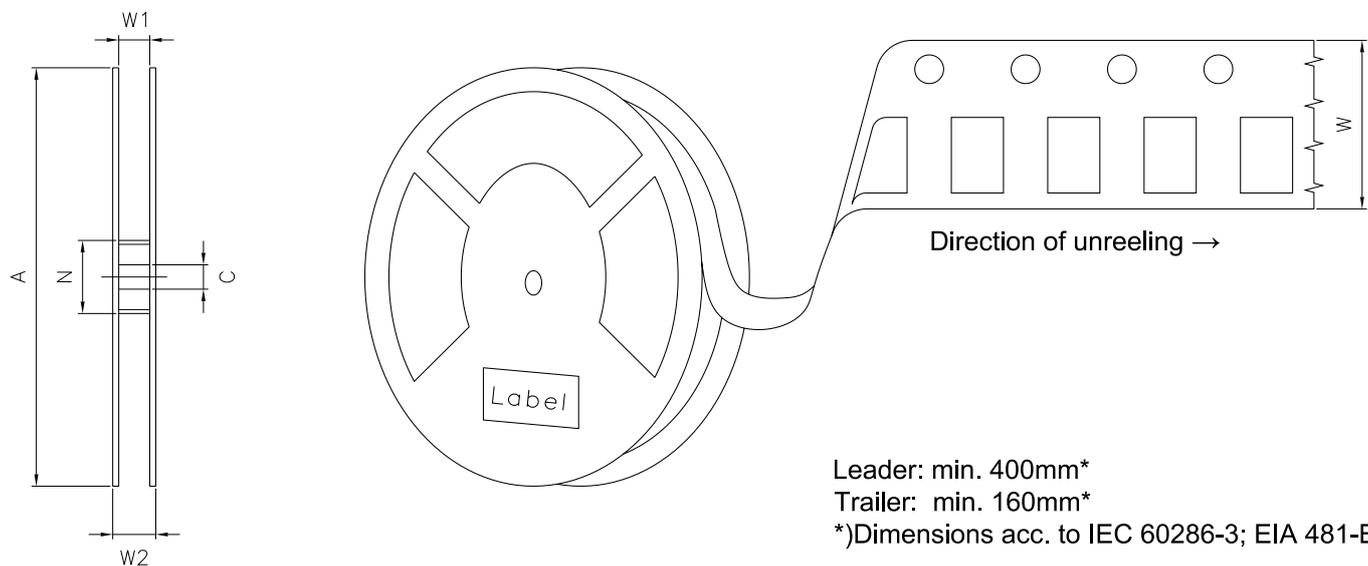
Taping ¹⁰⁾



C63062-A4053-B6 -04

Discontinued

Tape and Reel ¹¹⁾



Reel Dimensions

A	W	N_{min}	W_1	W_{2max}	Pieces per PU
180 mm	$8 + 0.3 / - 0.1$ mm	60 mm	$8.4 + 2$ mm	14.4 mm	4000

Discontinued

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890 ML Temp ST
X XXX °C X

(1T) LOT NO: 1234567890 (9D) D/C: 1234

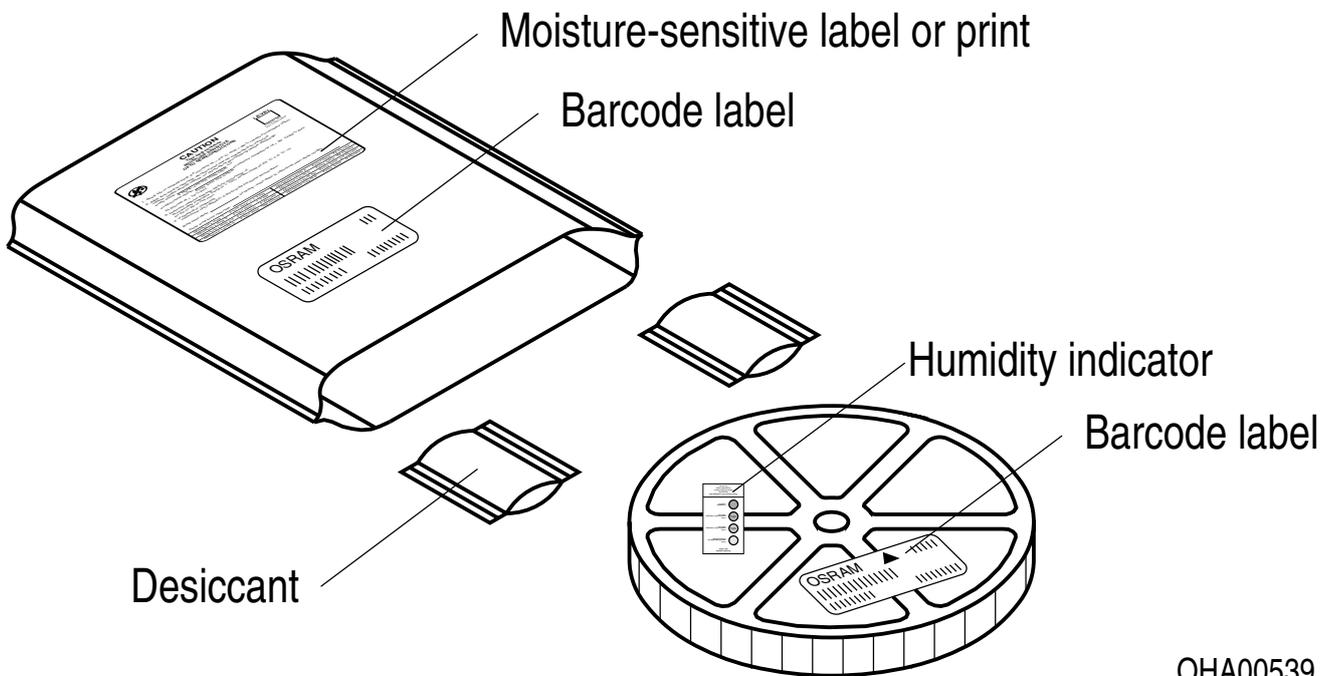
(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

Pack: RXX
DEMY XXX
X_X123_1234.1234 X



OHA04563

Dry Packing Process and Materials ¹⁰⁾

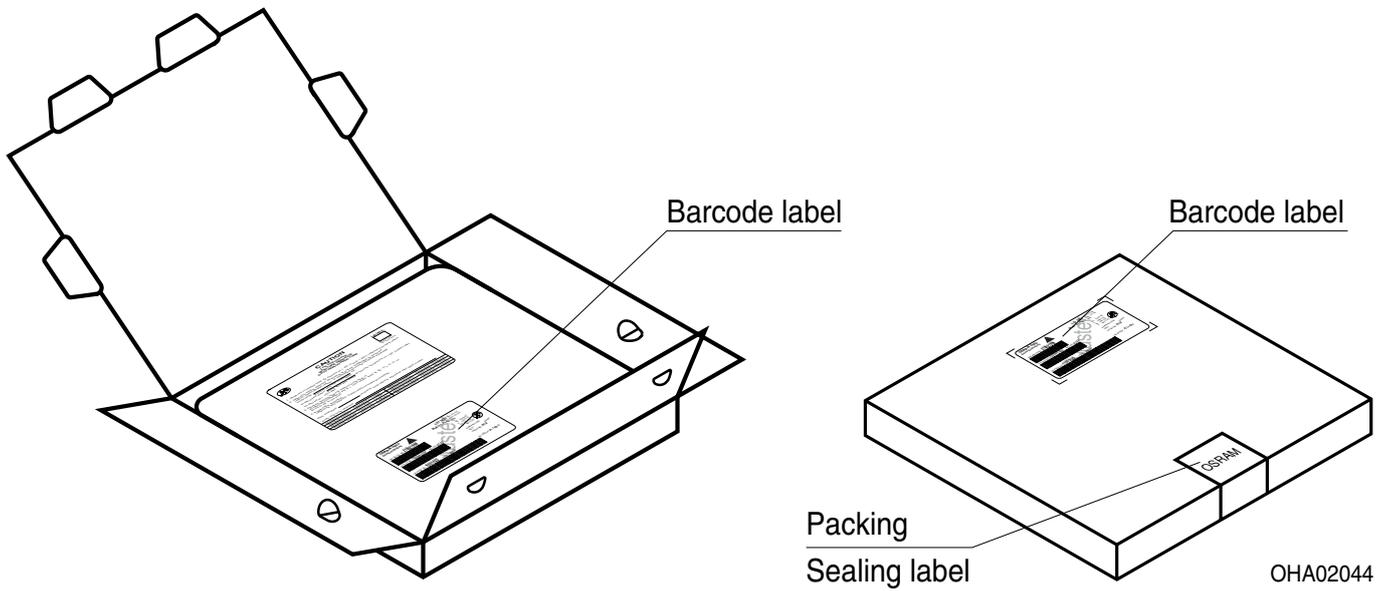


OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Discontinued

Schematic Transportation Box ¹⁰⁾



Dimensions of Transportation Box

Width	Length	Height
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm

Discontinued

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$).
- 2) **Operating Conditions:** Operating conditions according DC-derating (Max. Permissible Forward Current)
- 3) **Operating Conditions:** Operating conditions according Pulse-derating (Permissible Pulse Handling Capability)
- 4) **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- 5) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (acc. to GUM with a coverage factor of $k = 3$).
- 6) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of $k = 3$).
- 7) **Thermal Resistance:** The typical R_{th} value is the average of a distribution. The value was determined on a sample basis and is not monitored.
- 8) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 9) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 10) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 11) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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